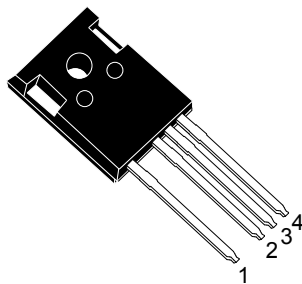
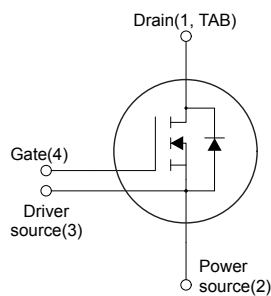


Automotive-grade silicon carbide Power MOSFET 650 V, 55 mΩ typ., 45 A in an HiP247-4 package



HiP247-4


ND11TPS2DS3G4



Features

Order code	V_{DS}	$R_{DS(on)}$ max.	I_D
SCTWA35N65G2V4AG	650 V	67 mΩ	45 A

- AEC-Q101 qualified 
- Very fast and robust intrinsic body diode
- Low capacitances
- Source sensing pin for increased efficiency
- Very high operating junction temperature capability ($T_J = 200\text{ °C}$)

Applications

- Main inverter (electric traction)
- DC/DC converter for EV/HEV
- On board charger (OBC)

Description

This silicon carbide Power MOSFET device has been developed using ST's advanced and innovative 2nd generation SiC MOSFET technology. The device features remarkably low on-resistance per unit area and very good switching performance. The variation of switching loss is almost independent of junction temperature.

Product status link

[SCTWA35N65G2V4AG](#)

Product summary

Order code	SCTWA35N65G2V4AG
Marking	SCT35N65G2VAG
Package	HiP247-4
Packing	Tube

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	650	V
V_{GS}	Gate-source voltage	-10 to 22	V
	Gate-source voltage (recommended operating range)	-5 to 18	
I_D	Drain current (continuous) at $T_C = 25\text{ °C}$	45	A
	Drain current (continuous) at $T_C = 100\text{ °C}$	35	
$I_{DM}^{(1)}$	Drain current (pulsed)	90	A
P_{TOT}	Total power dissipation at $T_C = 25\text{ °C}$	240	W
T_{stg}	Storage temperature range	-55 to 200	°C
T_J	Operating junction temperature range		°C

1. Pulse width is limited by safe operating area.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance, junction-to-case	0.72	°C/W
R_{thJA}	Thermal resistance, junction-to-ambient	40	°C/W

2 Electrical characteristics

($T_C = 25\text{ °C}$ unless otherwise specified).

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}, I_D = 1\text{ mA}$	650			V
I_{DSS}	Zero gate voltage drain current	$V_{GS} = 0\text{ V}, V_{DS} = 650\text{ V}$			5	μA
I_{GSS}	Gate-body leakage current	$V_{DS} = 0\text{ V}, V_{GS} = -10\text{ to }22\text{ V}$			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 1\text{ mA}$	1.8	3.2	5	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 20\text{ V}, I_D = 20\text{ A}$		45	67	m Ω
		$V_{GS} = 18\text{ V}, I_D = 20\text{ A}$		55		
		$V_{GS} = 20\text{ V}, I_D = 20\text{ A}, T_J = 200\text{ °C}$		68		

Table 4. Dynamic, based on HiP247 package option

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 400\text{ V}, f = 1\text{ MHz}$	-	1370	-	pF
C_{oss}	Output capacitance		-	125	-	pF
C_{rss}	Reverse transfer capacitance		-	30	-	pF
R_g	Gate input resistance	$f = 1\text{ MHz}, I_D = 0\text{ A}$	-	2	-	Ω
Q_g	Total gate charge	$V_{DD} = 400\text{ V}, I_D = 20\text{ A}, V_{GS} = 0\text{ to }20\text{ V}$	-	73	-	nC
Q_{gs}	Gate-source charge		-	14	-	nC
Q_{gd}	Gate-drain charge		-	27	-	nC

Table 5. Switching energy (inductive load), based on HiP247 package option

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
E_{on}	Turn-on switching energy	$V_{DD} = 400\text{ V}, I_D = 20\text{ A},$	-	100	-	μJ
E_{off}	Turn-off switching energy	$R_G = 4.7\text{ }\Omega, V_{GS} = -5\text{ to }20\text{ V}$	-	35	-	μJ

Table 6. Switching times, based on HiP247 package option

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 400\text{ V}, I_D = 20\text{ A},$ $R_G = 4.7\text{ }\Omega, V_{GS} = -5\text{ to }20\text{ V}$	-	16	-	ns
t_f	Fall time		-	14	-	ns
$t_{d(off)}$	Turn-off delay time		-	35	-	ns
t_r	Rise time		-	9	-	ns

Table 7. Reverse diode characteristics, based on HiP247 package option

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{SD}	Forward on voltage	$V_{GS} = 0\text{ V}$, $I_F = 20\text{ A}$,	-	3.3	-	V
t_{rr}	Reverse recovery time	$V_{DD} = 400\text{ V}$, $I_F = 20\text{ A}$, $di/dt = 1000\text{ A}/\mu\text{s}$	-	18	-	ns
Q_{rr}	Reverse recovery charge		-	85	-	nC
I_{RRM}	Reverse recovery current		-	7	-	A

2.1 Electrical characteristics (curves), based on HiP247 package option

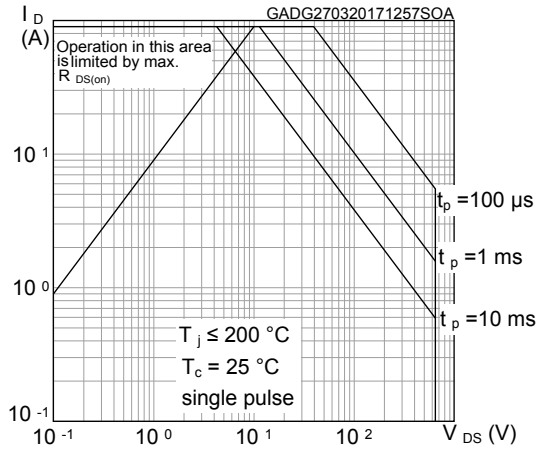
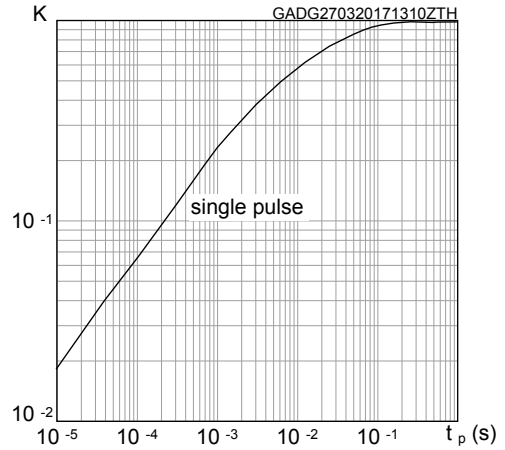
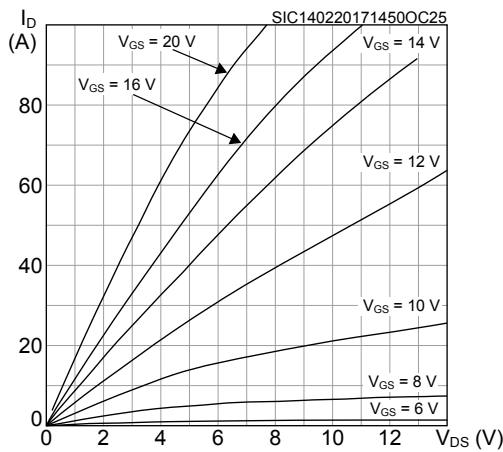
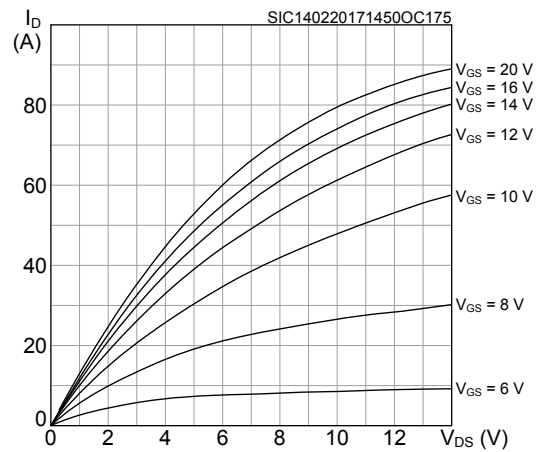
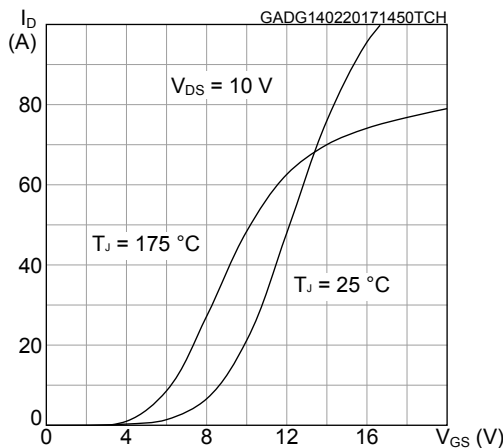
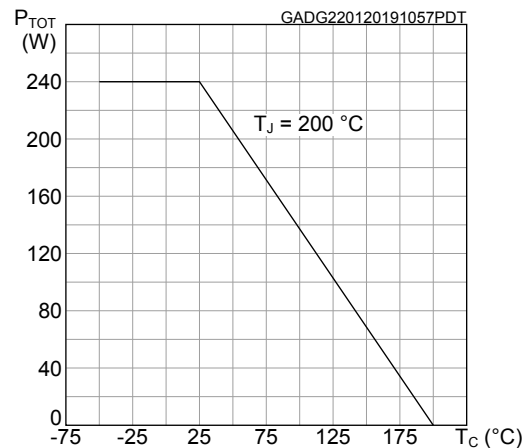
Figure 1. Safe operating area

Figure 2. Normalized thermal impedance

Figure 3. Output characteristics ($T_J = 25\text{ °C}$)

Figure 4. Output characteristics ($T_J = 175\text{ °C}$)

Figure 5. Transfer characteristics

Figure 6. Power dissipation


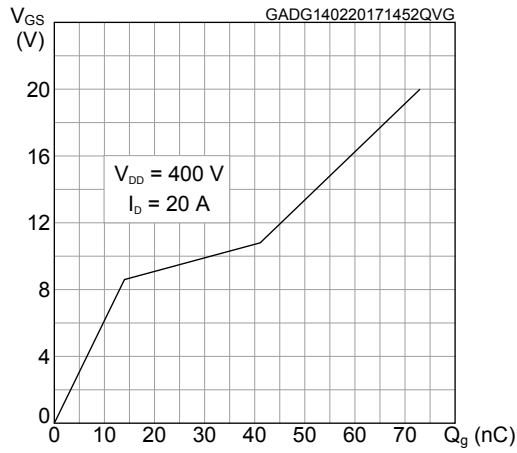
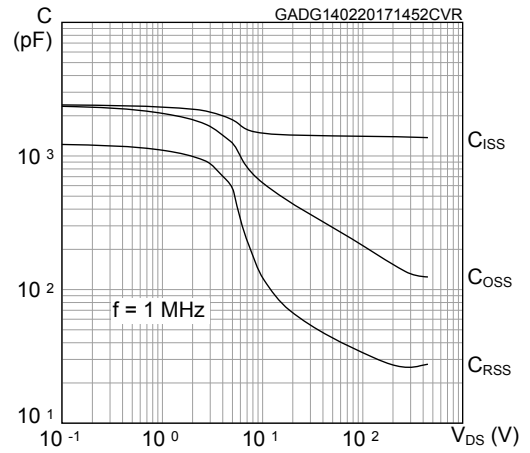
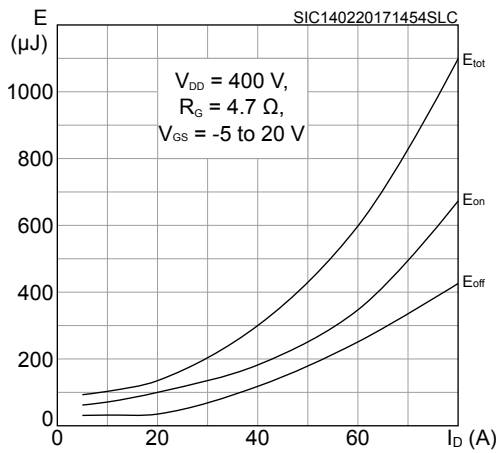
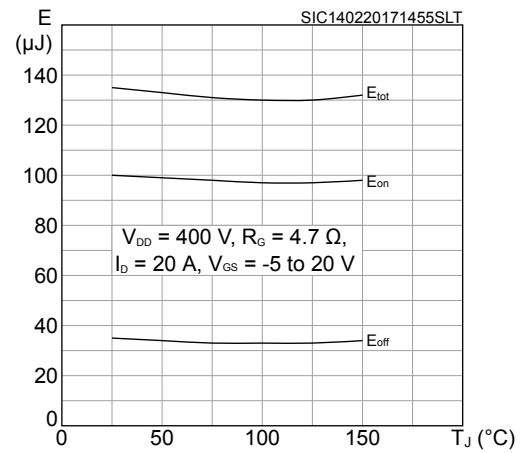
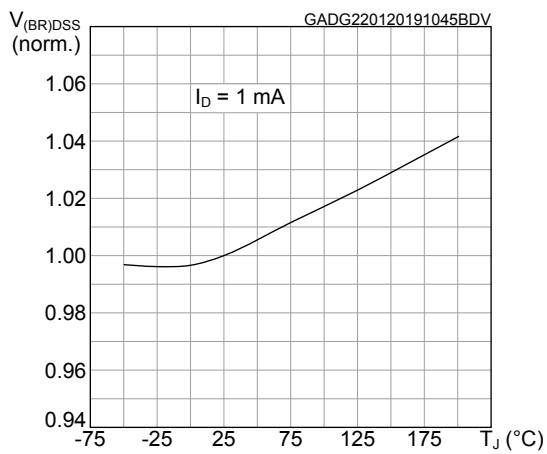
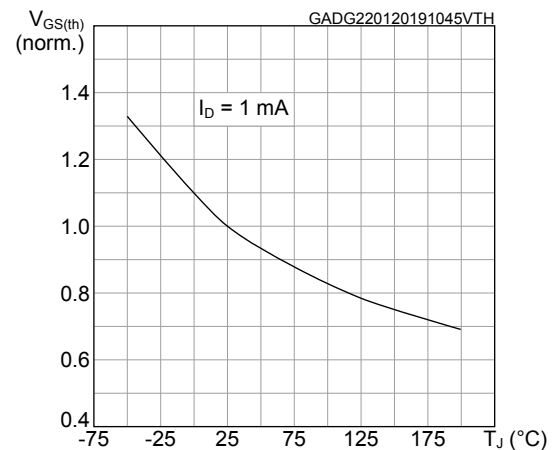
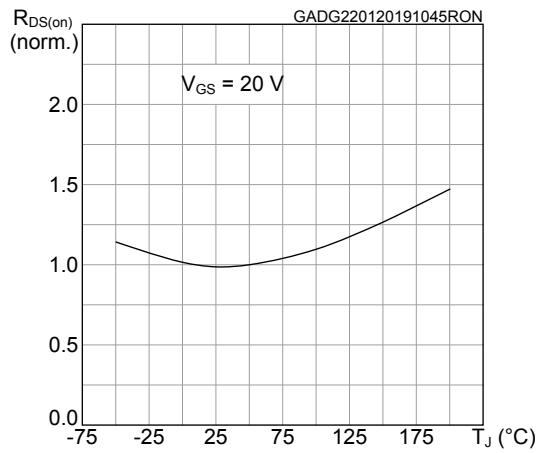
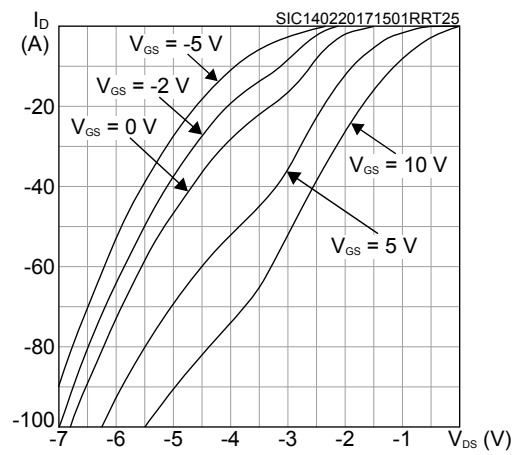
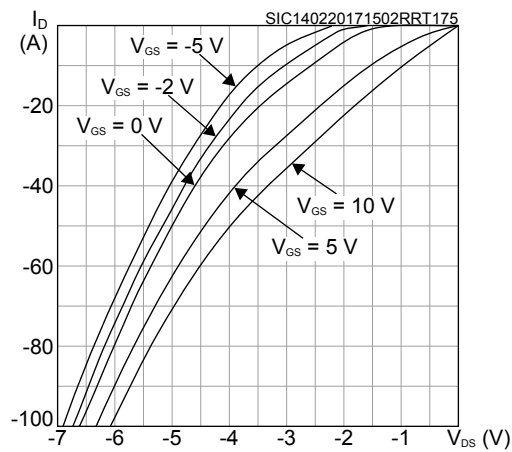
Figure 7. Gate charge vs gate-source voltage

Figure 8. Capacitance variations

Figure 9. Switching energy vs drain current

Figure 10. Switching energy vs junction temperature

Figure 11. Normalized $V_{(BR)DSS}$ vs temperature

Figure 12. Normalized gate threshold voltage vs temperature


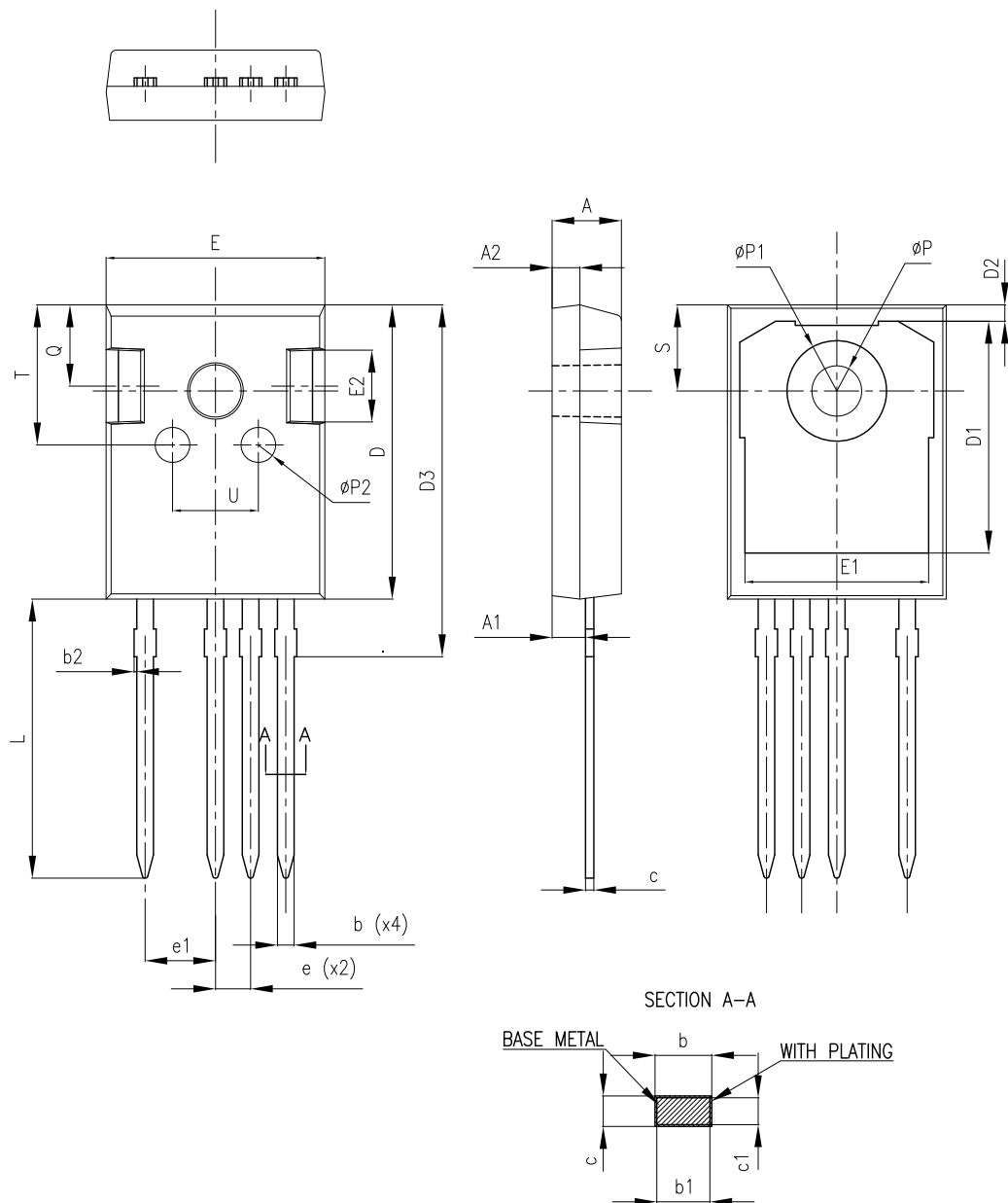
Figure 13. Normalized on-resistance vs temperature

Figure 14. Reverse conduction characteristics ($T_J = 25$ °C)

Figure 15. Reverse conduction characteristics ($T_J = 175$ °C)


3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

3.1 HiP247-4 package information

Figure 16. HiP247-4 package outline



8405626_2

Table 8. HiP247-4 mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16		1.29
b1	1.15	1.20	1.25
b2	0		0.20
c	0.59		0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.20	1.35
D3	24.97	25.12	25.27
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	2.44	2.54	2.64
e1	4.98	5.08	5.18
L	19.80	19.92	20.10
P	3.50	3.60	3.70
P1			7.40
P2	2.40	2.50	2.60
Q	5.60		6.00
S		6.15	
T	9.80		10.20
U	6.00		6.40

Revision history

Table 9. Document revision history

Date	Version	Changes
02-Dec-2020	1	First release.

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